DATA SHEET

MOS FIELD EFFECT TRANSISTORS **2SK2371/2SK2372**

SWITCHING N-CHANNEL POWER MOS FET INDUSTRIAL USE

DESCRIPTION

EC

The 2SK2371/2SK2372 is N-Channel MOS Field Effect Transistor designed for high voltage switching applications.

FEATURES

• Low On-Resistance

2SK2367: $R_{DS(ON)} = 0.25 \Omega (V_{GS} = 13 V, I_D = 10 A)$

2SK2368: Rds(on) = 0.27 Ω (Vgs = 13 V, Id = 10 A)

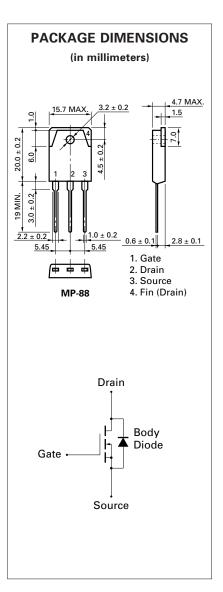
- Low C_{iss} C_{iss} = 3600 pF TYP.
- High Avalanche Capability Ratings

ABSOLUTE MAXIMUM RATINGS (T_A = 25 $^{\circ}$ C)

Drain to Source Voltage (2SK2371/2SK2372)	Vdss	450/500	V
Gate to Source Voltage	Vgss	±30	V
Drain Current (DC)	D(DC)	±25	А
Drain Current (pulse)*	D(pulse)	±100	А
Total Power Dissipation (Tc = 25 °C)	P T1	160	W
Total Power Dissipation (T _a = 25 $^{\circ}$ C)	Рт2	3.0	W
Channel Temperature	Tch	150	°C
Storage Temperature	Tstg	-55 ~ +150	°C
Single Avalanche Current**	las	25	А
Single Avalanche Energy**	Eas	446	mJ
* PW \leq 10 μ s, Duty Cycle \leq 1 %			

** Starting T_{ch} = 25 °C, R_G = 25 Ω , V_{GS} = 20 V \rightarrow 0

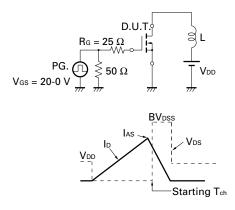
The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device is actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.



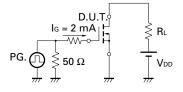
ELECTRICAL CHARACTERISTICS (T_A = 25 °C)

CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITION	
Drain to Source On-Resistance	RDS(on)		0.2	0.25	Ω	$V_{GS} = 10 V$	2SK2371
			0.22	0.27		ID = 13 A	2SK2372
Gate to Source Cutoff Voltage	$V_{GS(off)}$	2.5		3.5	V	$V_{DS} = 10 V, I_{D} = 1 mA$	
Forward Transfer Admittance	y _{fs}	8.0			S	Vds = 10 V, Id = 13 A	
Drain Leakage Current	ldss			100	μA	Vds = Vdss, Vgs = 0	
Gate to Source Leakage Current	lgss			±100	nA	$V_{GS} = \pm 30 \text{ V}, \text{ V}_{DS} = 0$	
Input Capacitance	Ciss		3600		pF	V _{DS} = 10 V	
Output Capacitance	Coss		700		pF	Vgs = 0	
Reverse Transfer Capacitance	Crss		50		pF	f = 1 MHz	
Turn-On Delay Time	td(on)		40		ns	ID = 13 A	
Rise Time	tr		70		ns	Vgs = 10 V	
Turn-Off Delay Time	td(off)		160		ns	V _{DD} = 150 V	
Fall Time	tr		60		ns	$R_G = 10 \Omega R$	L = 11.5 Ω
Total Gate Charge	QG		95		nC	ID = 25 A	
Gate to Source Charge	Qgs		20		nC	V _{DD} = 400 V	
Gate to Drain Charge	Qgd		40		nC	$V_{GS} = 10 V$	
Body Diode Forward Voltage	V _{F(S-D)}		1.0		V	IF = 25 A, VG	s = 0
Reverse Recovery Time	trr		500		ns	IF = 25 A, VG	s = 0
Reverse Recovery Charge	Qrr		4.5		μC	di/dt = 50 A/	uS

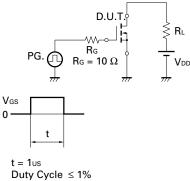
Test Circuit 1 Avalanche Capability

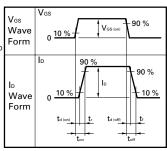


Test Circuit 3 Gate Charge



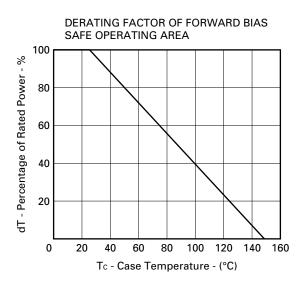
Test Circuit 2 Switching Time



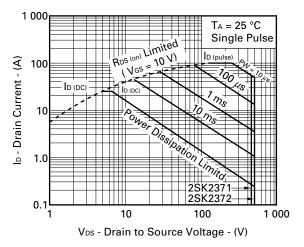


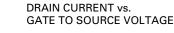
The application circuits and their parameters are for references only and are not intended for use in actual design-in's.

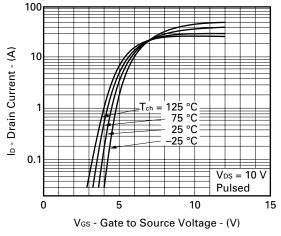
TYPICAL CHARACTERISTICS ($T_A = 25 \ ^{\circ}C$)

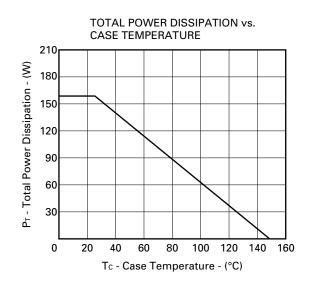


FORWARD BIAS SAFE OPERATING AREA

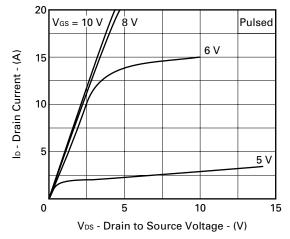


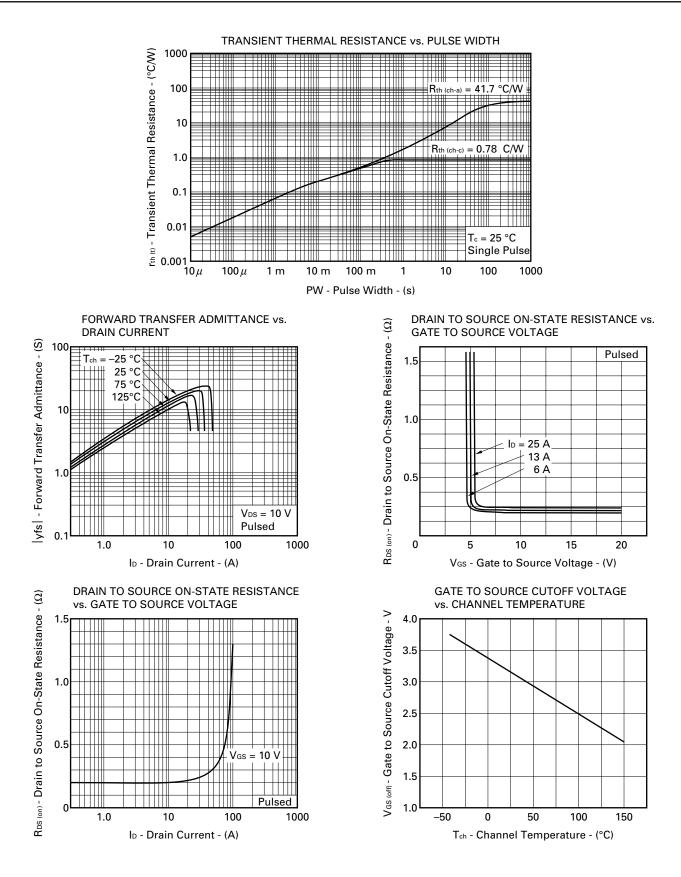


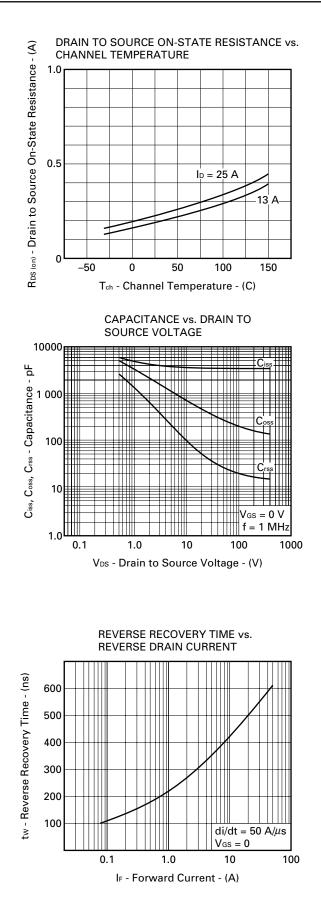


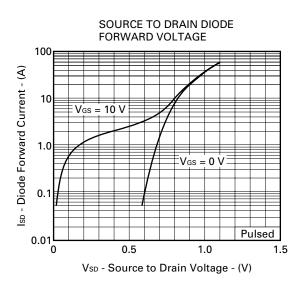


DRAIN CURRENT vs. DRAIN TO SOURCE VOLTAGE

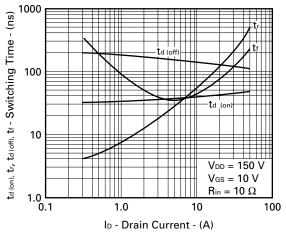


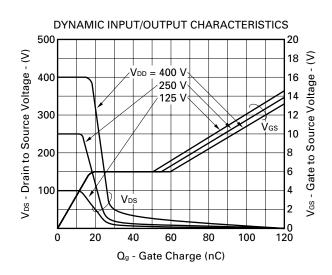


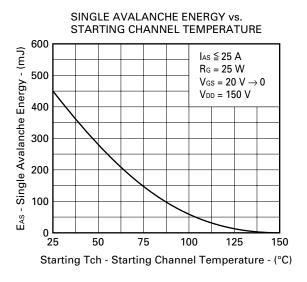


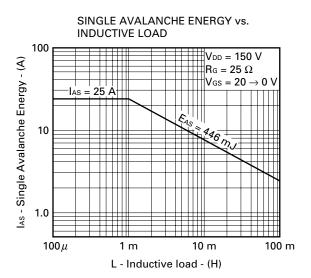












REFERENCE

Document Name	Document No.
NEC semiconductor device reliability/quality control system.	TEI-1202
Quality grade on NEC semiconductor devices.	IEI-1209
Semiconductor device mounting technology manual.	IEI-1207
Semiconductor device package manual.	IEI-1213
Guide to quality assurance for semiconductor devices.	MEI-1202
Semiconductor selection guide.	MF-1134
Power MOS FET features and application switching power supply.	TEA-1034
Application circuits using Power MOS FET.	TEA-1035
Safe operating area of Power MOS FET.	TEA-1037

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Anti-radioactive design is not implemented in this product.

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